PCN Number:			20221003001.0					PCN Date:		October 03, 2022	
Title: Correct top n			narking for TPS7A0318DBV from 21VF to 2CET								
<b>Customer Contact:</b>			PCN Manager Dept: 0			Quality Services					
Change Type:											
Assembly Site				Assembly Process			SS		Assembly Materials		
Design					Datasheet				Mechanical Specification		
Test Site				Packing/Shipping/Labeling					Test Process		
☐ Wafer Bump Site					Wafer Bump Material				Wafer Bump Process		
☐ Wafer Fab Site				<u> </u>	Wafer Fab Materials				Wafer Fa	b Process	
					Part number change						
Day	PCN Details										
Des	Description of Change:										
	- What		Current					New			
	Device ID		21VF					2CET			
Rea	Reason for Change:										
Improved Device traceability											
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):											
None											
Cha	ange	s to product i	den	tific	ation re	sulting	from this PCN:				
		evice symboliza	atio	n rov	W						
Pro	duct	Affected:									
TP	S7A03	318DBVR									

For questions regarding this notice, e-mails can be sent to the contacts shown below or your local Field Sales Representative.

Location	E-Mail				
WW Change Management Team	PCN www admin team@list.ti.com				

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